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RE



U.S. DEPARTMENT OF COMMERCE
U.S. Patent and Trademark Office
Docket No. 0756-7105

102468593

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Atsuo ISOBE, Koji DAIRIKI, Hiroshi SHIBATA, Chiho KOKUBO,
Tatsuya ARAO, Masahiko HAYAKAWA, Hidekazu MIYAIRI,
Akihisa SHIMOMURA, Koichiro TANAKA, Shunpei YAMAZAKI,
and Mai AKIBA

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: 04/17/2003; 05/12/2003; 05/17/2003
05/12/2003; 04/21/2003; 04/21/2003; 04/17/2003;
04/17/2003; 04/18/2003; 04/22/2003; 05/09/2003

2. Name and address of receiving party(ies)

Name: Semiconductor Energy Laboratory Co., Ltd.

Internal Address: _____

Street Address: 398 Hase

Atsugi-shi, Kanagawa-ken

Country: Japan Postal Code: 243-0036

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s);

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)
10/330,024

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Attorney Name: Eric J. Robinson
Firm Name: Robinson Intellectual Property Law
Office, P.C.
Internal Address: PMB 955
Street Address: 21010 Southbank Street
City: Potomac Falls State: VA Zip: 20165

7. Total number of applications and patents involved: 18. Total fee (37 CFR 3.41).....\$40.00

- ☒ Enclosed
☐ Authorized to be charged to deposit account

6. Submission Type

- ☒ New
☐ Resubmission (Non-Recordation)
Document ID# _____
☐ Correction of PTO Error
Reel # _____ Frame # _____
☐ Corrective Document
Reel # _____ Frame # _____

9. Deposit account number: 50-2280

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

10. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Eric J. Robinson

Name of Person Signing

Signature

June 2, 2003

Date

Total number of pages including cover sheet, attachments, and documents: _____

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on June 2, 2003.

Jose M. Fichas

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments

PATENT
REEL: 014140 FRAME: 0125

ASSIGNMENT

Serial No. 10/330,024

Filed December 27, 2002

WHEREAS, Atsuo ISOBE, Koji DAIRIKI, Hiroshi SHIBATA, Chiho KOKUBO, Tatsuya ARAO, Masahiko HAYAKAWA, Hidekazu MIYAIRI, Akihisa SHIMOMURA, Koichiro TANAKA, Shunpei YAMAZAKI and Mai AKIBA (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICE PRODUCING SYSTEM for which an application for Letters Patent of the United States of America has been executed by the undersigned on _____, and;

WHEREAS, Semiconductor Energy Laboratory Co., Ltd. of 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein

hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of ROBINSON INTELLECTUAL PROPERTY LAW OFFICE the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness thereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date <u>04/17/2003</u>	Signature <u>Atsuo Isebe</u> Name <u>Atsuo ISOBE</u>
Date <u>05/12/2003</u>	Signature <u>Koji Daiki</u> Name <u>Koji DAIRIKI</u>
Date _____	Signature _____ Name <u>Hiroshi SHIBATA</u>
Date <u>05/12/2003</u>	Signature <u>Chiho Kokubo</u> Name <u>Chiho KOKUBO</u>
Date <u>04/21/2003</u>	Signature <u>Tatsuya ARAO</u> Name <u>Tatsuya ARAO</u>
Date <u>04/21/2003</u>	Signature <u>Masahiko Hayakawa</u> Name <u>Masahiko HAYAKAWA</u>
Date <u>04/17/2003</u>	Signature <u>Hidekazu MIYAIRI</u> Name <u>Hidekazu MIYAIRI</u>
Date <u>04/17/2003</u>	Signature <u>Akihisa SHIMOMURA</u> Name <u>Akihisa SHIMOMURA</u>
Date <u>04/18/2003</u>	Signature <u>Koichiro TANAKA</u> Name <u>Koichiro TANAKA</u>
Date <u>04/22/2003</u>	Signature <u>Shunpei Yamazaki</u> Name <u>Shunpei YAMAZAKI</u>

Date 05/09/2003

Signature Mai Akiba

Name Mai AKIBA

This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed by at least two other persons who should sign here.

Witness _____

Signature _____

Witness _____

Signature _____

Witness _____

Signature _____

ASSIGNMENT

Serial No. 10/330,024

Filed December 27, 2002

WHEREAS, Atsuo ISOBE, Koji DAIRIKI, Hiroshi SHIBATA, Chiho KOKUBO, Tatsuya ARAO, Masahiko HAYAKAWA, Hidekazu MIYAIRI, Akihisa SHIMOMURA, Koichiro TANAKA, Shunpei YAMAZAKI and Mai AKIBA (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICE PRODUCING SYSTEM for which an application for Letters Patent of the United States of America has been executed by the undersigned on _____, and;

WHEREAS, Semiconductor Energy Laboratory Co., Ltd. of 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

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The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein

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In witness thereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date _____	Signature _____ Name <u>Atsuo ISOBE</u>
Date _____	Signature _____ Name <u>Koji DAIRIKI</u>
Date <u>05/19/2003</u>	Signature <u>Hiroshi Shibata</u> Name <u>Hiroshi SHIBATA</u>
Date _____	Signature _____ Name <u>Chiho KOKUBO</u>
Date _____	Signature _____ Name <u>Tatsuya ARAO</u>
Date _____	Signature _____ Name <u>Masahiko HAYAKAWA</u>
Date _____	Signature _____ Name <u>Hidekazu MIYAIRI</u>
Date _____	Signature _____ Name <u>Akihisa SHIMOMURA</u>
Date _____	Signature _____ Name <u>Koichiro TANAKA</u>
Date _____	Signature _____ Name <u>Shunpei YAMAZAKI</u>

Date _____

Signature _____

Name Mai AKIBA

This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed by at least two other persons who should sign here.

Witness _____

Signature _____

Witness _____

Signature _____

Witness _____

Signature _____